MODEL NO. : TM024HDH29



ISSUED DATE: _	2010-3-29	
VERSION : _	Ver 1.0	
	ry Specification duct Specificati	

Notes

SHANGHAI TIANMA Confirmed:

Approved by

Customer:

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice



Table of Contents

Cov	/ersheet	 1
Tab	le of Contents	 2
Red	cord of Revision	 3
1	General Specifications	. . 4
2	Input/Output Terminals	5
3	Absolute Maximum Ratings	7
4	Electrical Characteristics	8
5		
6		
7		
8		
9	_	
_	Precautions for Use of LCD Modules	22



Record of Revision

Rev	Issued Date	Description	Editor
1.0	2010-3-29	Preliminary Specification Release	Jianchuan_wang
			•



1 General Specifications

	Feature	Spec	
	Size	2.4 inch	
	Resolution	240(RGB) x 320	
	Interface	CPU 8/16 bits	
	Color Depth	262k	
	Technology Type	a-Si	
Display Spec	Pixel Pitch (mm)	0.153x 0.153	
	Pixel Configuration	R.G.B Vertical Stripe	
	Display Mode	TM with Normally White	
	Surface Treatment(Up Polarizer)	Clear Type (3H)	
	Viewing Direction	6 o'clock	
	Gray Scale Inversion Direction	12 o'clock	
	LCM (W x H x D) (mm)	42.72x60.26x3.40	
Mashaniasi	Active Area(mm)	36.72 x 48.96	
Mechanical Characteristics	With /Without TSP	Without TSP	
Onaracteristics	Weight (g)	TBD	
	LED Numbers	4 LEDs	
Electronic	Driver IC	IL9340	

Note 1:Viewing direction for best image quality is different from TFT definition, there is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: \pm 5%



2 Input/Output Terminals

2.1 TFT LCD Panel

No	Symbol	I/O	Description	Comment
1	NC1	-	NC	
2	NC2	-	NC	
3	NC3	-	NC	
4	IM3	I	Mode select	NOTE
5	NC4	-	NC	
6	RESET	I	Reset signal	
7	VSYNC	I	Frame synchronizing signal for RGB interface operation	
8	HSYNC	I	Line synchronizing signal for RGB interface operation	
9	DOTCLK	I	Dot clock signal for RGB interface operation	
10	DEN	I	Data enable signal for RGB interface operation	
11	DB17	I	Data Input	
12	DB16	l	Data Input	
13	DB15	I	Data Input	
14	DB14	I	Data Input	
15	DB13	I	Data Input	
16	DB12		Data Input	
17	DB11		Data Input	
18	DB10	11	Data Input	
19	DB9		Data Input	
20	DB8	l	Data Input	
21	DB7	l	Data Input	
22	DB6	l	Data Input	
23	DB5	I	Data input	
24	DB4	l	Data input	
25	DB3	I	Data input	
26	DB2	I	Data input	
27	DB1	I	Data input	
28	DB0	I	Data input	

SHANGHAI TIANMA MICRO-ELECTRONICS

TM024HDH29 V1.0

	0				<u> </u>
29	RD	I	Read enables signal		
30	WR	I	Write enables signal		
31	RS	I	Register select signal		
32	CS	I	Chip select signal		
33	VSS	Р	Power Ground		
34	VCC	Р	Power Supply		
35	LED-	Р	LED light cathode		
36	LED+	Р	LED light anode	A	

Note1: I/O definition: I-----Input O---Output P----Power/ Ground NC--- Not Connected Note2:

INAO	luta da a a	Data Bus Use				
IM3	Interface	Register/Content	GRAM			
0	8080 MCU 16_Bit Parallel	D8~D1	D17~D10,D8~D1			
1	8080 MCU 8_Bit Parallel	D17~D10	D17~D10			



3 Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

GND=0V, Ta=25℃

Item	Symbol	MIN	MAX	Unit	Remark
Logic Supply Voltage	IOVCC	-0.3	4.6	V	
Analog Supply Voltage	VCC	-0.3	4.6	V	
Input voltage	DB0-DB17,RD,RS,CS,WR	-0.3	IOVCC+0.5	V	
Back Light Forward Current	I _{LED}	-	25	mA	For each LED
Operating Temperature	T _{OPR}	-20	70	$^{\circ}\mathbb{C}$	
Storage Temperature	T _{STG}	-30	80	$^{\circ}\!\mathbb{C}$	



4 Electrical Characteristics

4.1 Driving TFT LCD Panel

GND=0V, Ta=25°C

Ite	m	Symbol	MIN	TYP	MAX	Unit	Remark
Logic S Volta		IOVCC	1.65	1.8/2.8	3.3	٧	Φ.
Analog Volta		VCC	2.3	2.8	3.3	٧	
Input Signal	Low Level	V_{IL}	0.8x IOVCC	ı	IOVCC	V	DB0-DB17,IM0,IM3,RD,
Voltage	High Level	V_{IH}	-	ı	0.2xIOVCC	>	RS,CS,WR,RESET
Output Signal	Low Level	V_{OL}	0.8xIOVCC	ı	-	V	
Voltage	High Level	V_{OH}	ı	1	0.2xIOVCC	V	
(Panel	+ LSI)	Black Mode (60Hz)	-	TBD	-	mW	
Pov	ver	8 Color Mode	-	TBD	-	mW	
Consu	mption	Sleeping Mode	-	TBD	-	mW	

4.2 Driving Backlight Ta=25℃

Item	Symbol	Min	Тур	Max	Unit	Remark
Forward Current	l _F	-	15	-	mA	For each LED
Forward Voltage	V_{F}	2.9	3.2	3.4	V	For each LED
Power Consumption	W_{BL}	-	192	-	mW	3 LEDs

Note1: Figure below shows the connection of backlight LED.

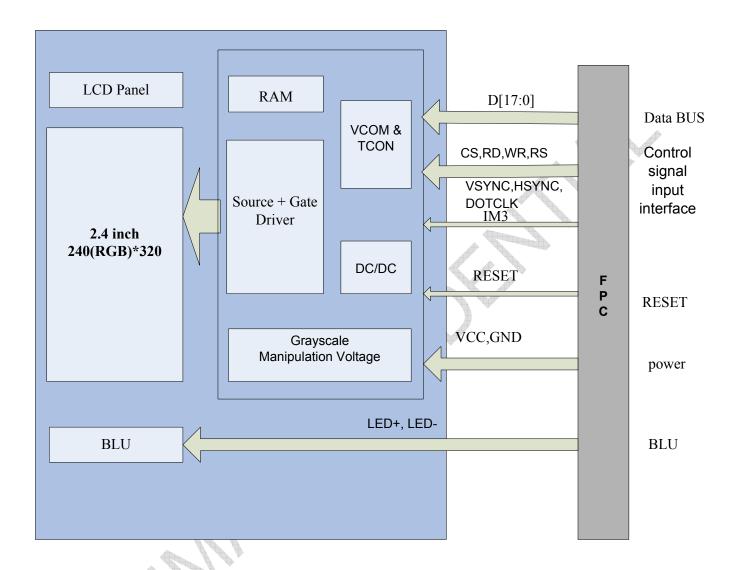


Note 2: One LED: $I_F = 15$ mA, $V_F = 3.2V$

Note 3: The life of LED: 20,000 hours



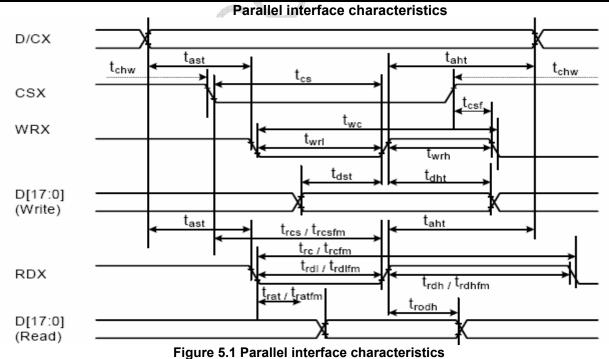
4.3 Block Diagram



5 Timing Chart

5.1 Interface Characteristics

Signal	Symbol	Parameter	min	max	Unit	Description
DCY	tast	Address setup time	0	-	ns	
DCX taht		Address hold time (Write/Read)	10	-	ns	
	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
CSX	trcs	Chip Select setup time (Read ID)	45	-	ns	
COX	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
	twc	Write cycle	66	-	ns	
WRX	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
RDX (FM)	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
	trc	Read cycle (ID)	160	-	ns	
RDX (ID)	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[47.0]	tdst	Write data setup time	10	-	ns	
D[17:0],	tdht	Write data hold time	10	-	ns	For maximum CL =20×F
D[15:0], D[8:0],	trat	Read access time	-	40	ns	For maximum CL=30pF For minimum CL=8pF
D[8:0], D[7:0]	tratfm	Read access time	-	340	ns	Torminimum of obt
D[1.0]	trod	Read output disable time	20	80	ns	



The information contained herein is the exclusive property of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation, and shall not be distributed, reproduced, or disclosed in whole or in part without prior written permission of SHANGHAI TIANMA MICRO-ELECTRONICS Corporation.

5.2 Registr Write/Read Timing Parameter

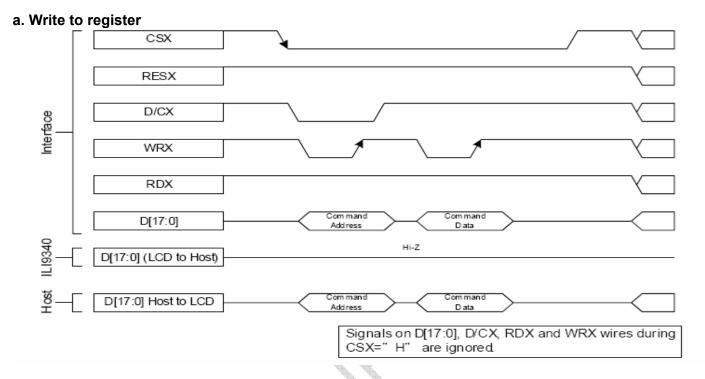


Figure 5.1 Register write timing in parallel bus system interface (for I80 series MPU)

b. Read to register

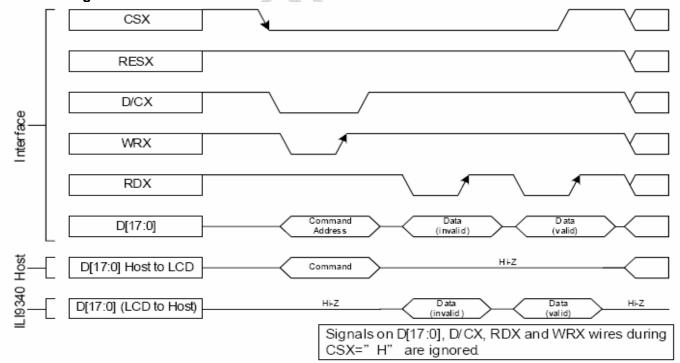
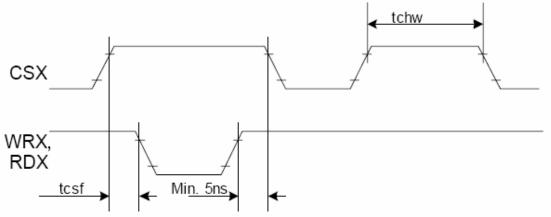
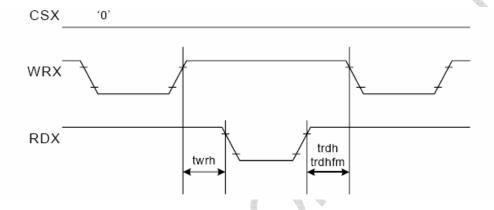


Figure 5.2 Register read timing in parallel bus system interface (for I80 series MPU)

CSX timings

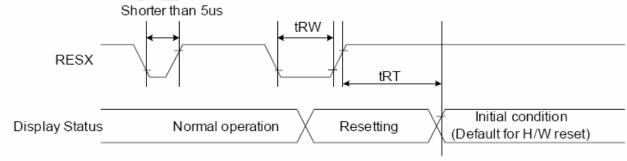


Write to read or read to write timings



5.3 Reset Timing Characteristics

Ta=25℃

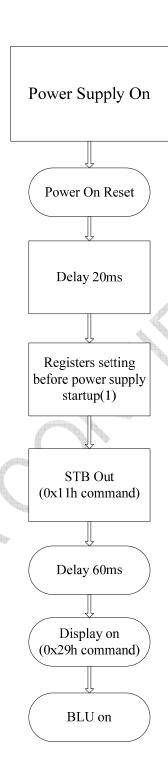


Signal	Symbol	Parameter	Min	Max	Unit
RESX	tRW	Reset pulse duration	10		uS
	tRT	Reset cancel		5 (note 1,5)	mS
				120 (note 1,6,7)	mS



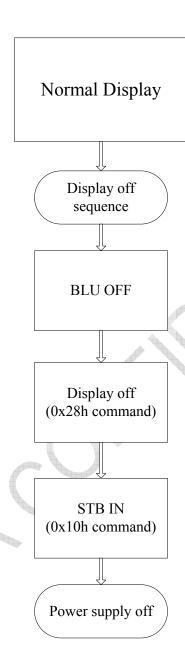
5.4 Power on/off Sequence

5.4.1 Power on sequence





5.4.2 Power off sequence





6 Optical Characteristics

Ta=25°C

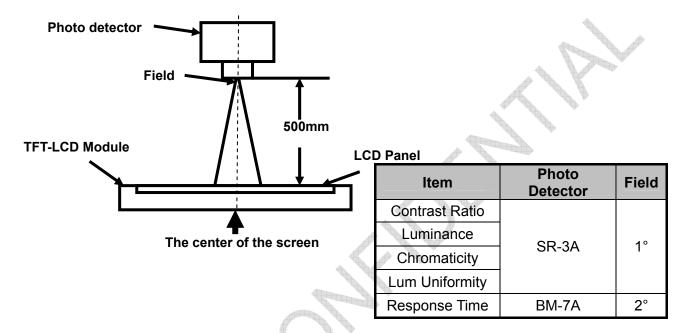
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
View Angles		θТ	- CR≧10	60	70	-	Degree	
		θВ		50	60	-		Note 2
		θL		60	70	-		Note 2
		θR		60	70	-		
Contrast Ratio		CR	θ=0°	400	500	-		Note1 Note3
Response Time		Ton	25℃	1	20	30	ms	Note1
		Toff				30		Note4
	White	х		0.231	0.281	0.331		
		у		0.258	0.308	0.358		
	Red	X		0.538	0.588	0.638		
Chromaticity		у	Backlight is on	0.289	0.339	0.389		Note5,
Chilomaticity	Green	X		0.278	0.328	0.378		Note1
		у		0.531	0.581	0.631		
	Blue	X		0.099	0.149	0.199		
		у		0.050	0.100	0.150		
Uniformity		U		-	80	-	%	Note1 Note6
NTSC				-	50	-	%	Note 5
Luminance		L		160	180	-	cd/m ²	Note1 Note7

Test Conditions:

- 1. For one LED: V_F =3.2V, $1/3xI_F$ =20mA, the ambient temperature is 25°C.
- 2. The test systems refer to Note 1 and Note 2.

Note 1: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 5 minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).

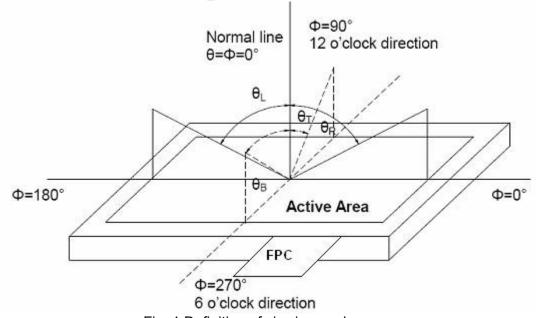


Fig. 1 Definition of viewing angle



Note 3: Definition of contrast ratio

Contrast ratio (CR) =
\[\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}} \]

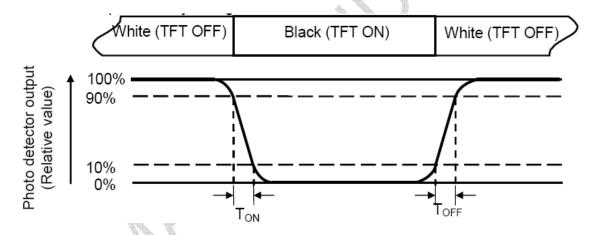
"White state ": The state is that the LCD should driven by Vwhite.

"Black state": The state is that the LCD should driven by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.



Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity(U) = Lmin/Lmax

L----- Active area length W----- Active area width

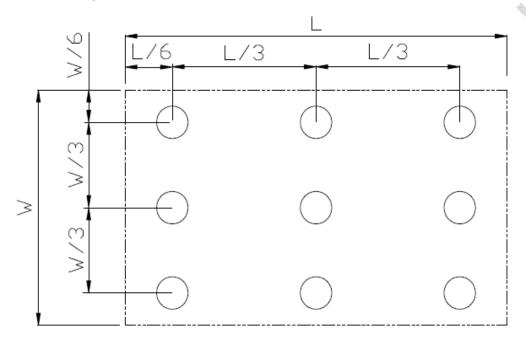


Fig. 2 Definition of uniformity

Lmax: The measured maximum luminance of all measurement position.

Lmin: The measured minimum luminance of all measurement position.

Note 7: Definition of Luminance:

Measure the luminance of white state at center point.



7 Environmental / Reliability Tests

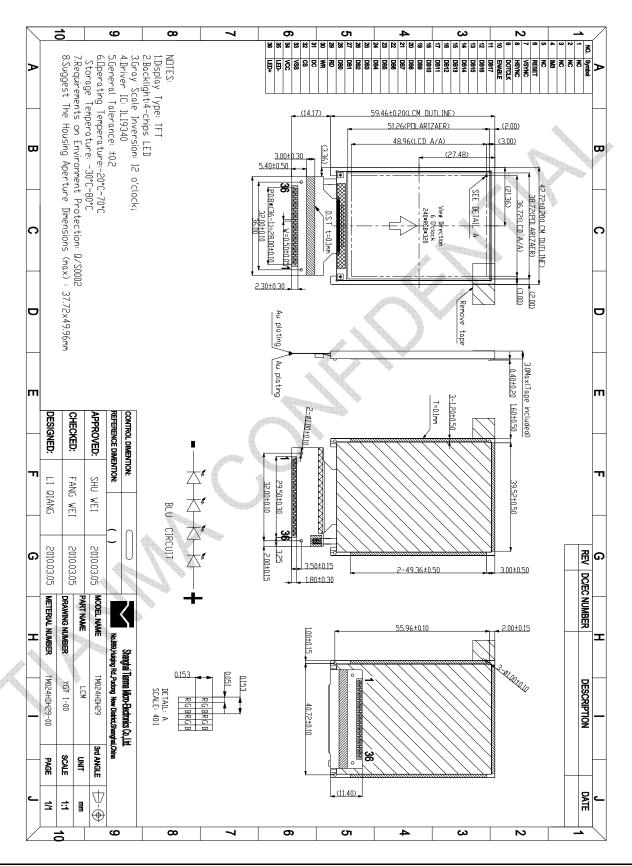
No	Test Item	Condition	Remarks
1	High Temperature Operation	Ts=+60℃, 240hrs	Note1 IEC60068-2-1:2007,GB2423.2-2008
2	Low Temperature Operation	Ta=-20℃, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
3	High Temperature Storage	Ta=+70℃, 240hrs	IEC60068-2-1:2007 GB2423.2-2008
4	Low Temperature Storage	Ta=-30℃, 240hrs	IEC60068-2-1:2007 GB2423.1-2008
5	High Temperature & High Humidity Storage	Ta=+60℃, 90% RH 240 hours	Note2 IEC60068-2-78 :2001 GB/T2423.3—2006
6	Thermal Shock (Non-operation)	-30°C 30 min~+70°C 30 min, Change time:5min, 20 Cycles	Start with cold temperature, End with high temperature, IEC60068-2-14:1984,GB2423.22-2002
7	Electro Static Discharge (Operation)	C=150pF, R=330Ω, 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times; (Environment: 15°C ~35°C, 30%~60%, 86Kpa~106Kpa)	IEC61000-4-2:2001 GB/T17626.2-2006
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition)	IEC60068-2-6:1982 GB/T2423.10—1995
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	IEC60068-2-27:1987 GB/T2423.5—1995
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	IEC60068-2-32:1990 GB/T2423.8—1995

Note1: Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

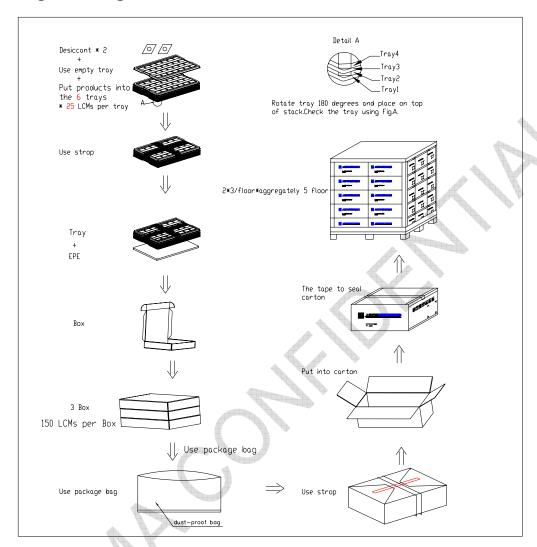


8 Mechanical Drawing





9 Packing Drawing





SHANGHAI TIANMA MICRO-ELECTRONICS

10 Precautions for Use of LCD Modules

- 11.1 Handling Precautions
- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol、
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
- 11.1.8.1 Be sure to ground the body when handling the LCD Modules.
- 11.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 11.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 11.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.
 - 11.2 Storage precautions
- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0° C \sim 40 $^{\circ}$ C Relatively humidity: ≤80%

- 11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
 - 11.3 Transportation Precautions:

The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.